

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

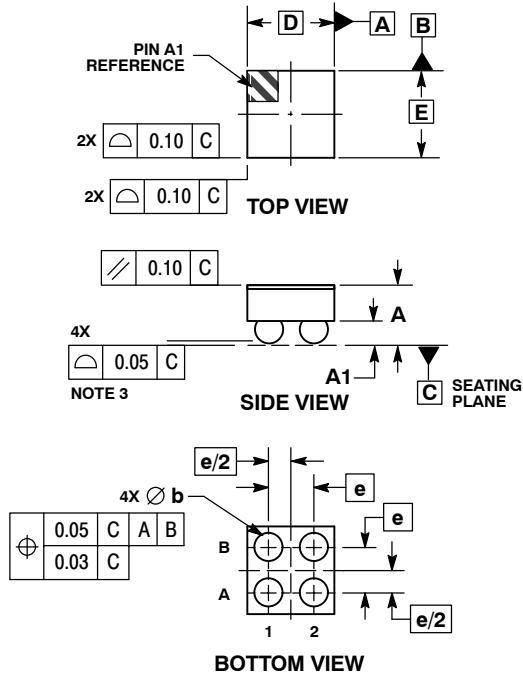
ON Semiconductor®



SCALE 4:1

CSP4, 1.06x1.06
CASE 568AD
ISSUE A

DATE 04 MAY 2012



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.

MILLIMETERS		
DIM	MIN	MAX
A	---	0.70
A1	0.21	0.26
b	0.30	0.34
D	1.06 BSC	
E	1.06 BSC	
e	0.50 BSC	

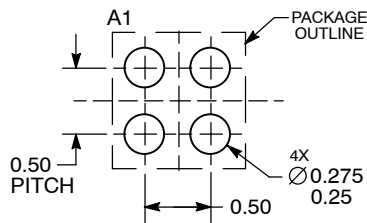
GENERIC MARKING DIAGRAM*



- XXX = Specific Device Code
- Y = Year
- WW = Work Week
- = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

RECOMMENDED SOLDERING FOOTPRINT*




DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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STATUS:	ON SEMICONDUCTOR STANDARD	
NEW STANDARD:		
DESCRIPTION:	CSP4, 1.06X1.06	PAGE 1 OF 2



ISSUE	REVISION	DATE
O	RELEASED FOR PRODUCTION. REQ. BY I. CAMBALIZA.	15 FEB 2012
A	CHANGED PACKAGE SIZE FROM 1.02X1.02 TO 1.06X1.06. REQ. BY I. CAMBALIZA.	04 MAY 2012

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